Oxygen Effect on Nanostructure SnO$_2$ Films and Morphology by Pulsed Laser Deposition

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ABSTRACT

This work includes the deposition of SnO$_2$ as a thin film on Si (111) by using the pulsed laser deposition method. The influences of oxygen pressure on the structural properties of Tin dioxide films were investigated. The X-ray diffraction results show that the structure of the films change from high polycrystalline to worse polycrystalline at an oxygen pressure of 10mbar. The surface morphology of the deposits materials was also studied by using a scanning electron microscope (SEM) and atomic force microscope (AFM). The results show that, the grain sizes of the nano particles observed at the surface depends on the oxygen pressure. As the pressure of the O$_2$ gas increases the densities of the particles increases too. An oxygen pressure of $5 \times 10^{-1}$ mbar was found the best pressure for the growth process. While the RMS roughness was seen to increase with increasing oxygen pressure. It was equal to (11.3 nm) for thin films deposited at (300)$^\circ$C.

Keywords: Pulsed Laser Deposition (PLD), SnO$_2$ thin films, nonstructural.

تاثير ضغط الأوكسجين على التراكيب النانوية والمورفولوجية لاغشية ثنائي أوكسيد السلنيد القصير بطريقة الترسيب بليزر النبضي

يتضمن هذا البحث ترسيب ثنائي أوكسيد السلنيد كأغشية رقيقة على السيليكون باستخدام طريقة الترسيب بليزر النبضي. وقد تم مناقشة تأثير ضغط الأوكسجين على الخصائص التركيبية لاغشية ثنائي أوكسيد السلنيد. و ببنت نتائج هجود الأشعة السينية أن تركيب الأغشية قد تغير من تأثير عالي الى تأثير قليل عند ضغط الأوكسجين 10 مبار. أما مورفولوجيا السطح للملاء المترسب فقد تم دراسته أيضا باستخدام المجهر الماسح الإلكتروني ومجهز القوى الذري. وقد بينت النتائج أن الحجم الجيبي للجسيمات النانوية عند السطح يعتمد على ضغط الأوكسجين. عند زيادة ضغط الأوكسجين فإن كلاه الجسيمات تزداد أيضا. حيث وجد أن ضغط أوكسجين ($5 \times 10^{-1}$ مبار كان أفضل ضغط خلال عملية النمو. بينما لوحظ بأن الحشوة انة تزداد مع زيادة ضغط الأوكسجين. و كانت تساوي (11.3) نانو لاغشية السلنيد عند درجة حرارة 300 مئوية.
INTRODUCTION

The SnO$_2$ films are n-type semiconductors with a direct optical band gap of about 3.87–4.3 eV. The valence band is closed shell of oxygen $2S^2$, $2P^6$ state mixed with some Sn states. The structure of the material in its bulk form is tetragonal rutile with lattice parameters $a = b = 4.737$ Å and $c = 3.816$ Å. However in thin film form, depending on the deposition technique its structure can be polycrystalline or amorphous. The grain size is typically 200–400 Å, which is highly dependent on deposition technique, temperature, doping level etc. SnO$_2$ films close to stoichiometric condition have low free carrier concentration and high resistivity, but non-stoichiometric SnO$_2$ films have high carrier concentration, conductivity and transparency. This comes about from an oxygen Vacancy in the structure so that the formula for the thin film material is SnO$_{2-x}$, where $x$ is the deviation from stoichiometry.

Tin dioxide (SnO$_2$) has many unique physical properties such as high electrical conductivity, high transmittance in the UV-visible region and unusual ferromagnetism, due to its n-type semiconductor behavior and wide band gap. As one of the most import transparent conductive oxide (TCO), SnO$_2$ and its alloys have been widely used in photovoltaic devices, solar cells, transparent electrodes and gas sensors.

There are many different techniques used for depositing tin oxide films: r. f. sputtering, dc-magnetron sputtering, thermal evaporation, ion beam deposition, rheotaxial growth and thermal oxidation (RGTO), chemical vapour deposition, spray pyrolysis, successive ionic layer deposition (SILD) and other chemical methods. Sberveglieri has presented a review of the techniques applied for tin oxide films deposition, all methods discussed require high substrate temperature or post deposition annealing in order to fabricate good quality polycrystalline films. High temperature, however, damages the surface of the films and increases the interface thickness, which has negative effect on the optical properties, especially on the wave guiding. Pulsed laser deposition technique was successfully applied for growing of quality thin tin oxide films. They were produced by ablation of either Sn metal target or SnO$_2$ target. The substrate use were Si, (001) SiO$_2$.

We report on deposition of tin oxide layers on Si (111) substrate by laser ablation of SnO$_2$ ceramic targets. Silicon oxide is used as a substrate, because of its transparency and low refractive. The deposits were characterized by X-ray diffraction (XRD) to examine their crystallinity and scanning electron microscopy (SEM) and atomic force microscopy (AFM) to observe the surface structure.

EXPERIMENTAL PROCEDURE

The deposition was carried out using a Q switched Nd:YAG laser at 532nm (pulse width 7nsec and laser fluence 1.2mJ/cm$^2$). The studied films were prepared by from pure Sno$_2$ targets films were grown by pulsed laser deposition on glass substrates kept distance of 4cm from the Sno$_2$ target. During the deposition the substrate temperatures (Ts) were kept at 300 C. The chamber shown in Figure (1). The SnO$_2$ disc was ablated from 10-100 pulses (10-20 min) to get single layered thin films.
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**Film characterization**

The crystalline structure of the films was determined by X-Ray Diffraction (XRD) measurements (Philips PW 1050, $\lambda=1.54 \text{ A}^0$) using Cu k$\alpha$. The surface morphology was examined by Scanning Electron Microscopy (SEM–JEOL 7000) and by atomic force microscopy (AFM) (Digital Instruments Nanoscope II). Scanning Probe Microscope (AA3000) was used.

**RESULT AND DISCUSSION**

Figure (2) shows the XRD patterns of the SnO$_2$ films grown on Si (111) at $T_s=300$ °C diffraction peaks located at $2\theta=28^\circ$ at laser fluence 1.2 J/cm$^2$ under oxygen pressures of ($5\times10^{-2}$, $5\times10^{-1}$ and 10 mbar). We can see that, under the oxygen pressure of $5\times10^{-2}$ mbar appearances of peak with low intensity. The films exhibit a dominant peak on $2\theta=27^\circ$, $2\theta=34^\circ$, $2\theta=52^\circ$ corresponding to the (110), (101), (211) peaks respectively as shown in Figure (2-a) whereas, at the pressure $5\times10^{-1}$ mbar as shown in Figure (2-b), the films exhibit a dominant peak on $2\theta=27^\circ$, $2\theta=34^\circ$, $2\theta=52^\circ$ corresponding to the (110), (101), (211) peaks respectively with high intensity and a appearances of peak on $2\theta=38^\circ$, $2\theta=54.3^\circ$ corresponding to the (200), (220) peaks respectively. The increase in peak intensity indicates an improvement in the crystallinity of the films. This leads to decrease in Full Width at Half Maximums (FWHM) of peak and increase in grain size [6] whereas, at the pressure 10 mbar as shown in Figure (2-c), the films became amorphous and just has a single line of Si(111) substrate.

However, in the case of low oxygen pressure $5\times10^{-2}$ mbar the interaction between the ablated species and oxygen molecules was very weak in connection, which resulted in ablated species with sufficiently high kinetic energy to form polycrystalline. When oxygen partial pressure increased, the kinetic energy of the
ablated species was presumably reduced and the crystalline of it becomes high polycrystalline. When the oxygen pressure further increased to 10mbar, the SnO$_2$ films became amorphous, indicating that the pressure was so high that the plasma form the target was prevented from reaching the surface of the substrates and the kinetic energy was so low that the film of a poor crystalline formed[7]

![Figure 2](image-url)

**Figure (2) XRD patterns of SnO$_2$ films grown on Si at various oxygen pressures a) $5 \times 10^{-2}$ mbar  b) $5 \times 10^{-1}$ mbar c).**

The AFM images of the pure SnO$_2$/Si films deposited at substrate temperature 300°C and at oxygen pressures of ($5 \times 10^{-2}$, $5 \times 10^{-1}$ and 10 mbar) and 1.2 J/cm$^2$ laser fluence energy are shown in figure (3). The AFM images of the pure SnO$_2$ thin films observed increasing O$_2$ pressure which probably leads to the sharp increase of the surface roughness. The RMS roughness values are (7.5, 11.3 and .4.3 nm) for thin films deposited at (a=$5 \times 10^{-2}$, b= $5 \times 10^{-1}$ and c=10 mbar ) respectively . The increasing of oxygen pressure presents a very homogeneous distribution of the nanoparticles. For that morphology, the buffer O$_2$ gas pressure has influence on the nanostructure of the film surface at the range of
several nm. It means that the interaction of the evaporated particles Sn with buffer O\textsubscript{2} gas produced nanoparticles consisting of Sn and O\textsubscript{2} low [8] as shown in Table (1).

The SEM images of the films deposited at fixed substrate temperature of 300 °C and at oxygen pressures of (5 × 10\textsuperscript{-2}, 5 × 10\textsuperscript{-1} and 10 mbar) and 1.2 J/cm\textsuperscript{2} laser fluence energy are shown in figure (4). It is evident that quite different surface morphologies are evolved depending on O\textsubscript{2} pressure during film growth.

As shown in Fig(4) the growth at O\textsubscript{2} pressure of 5 × 10\textsuperscript{-1} mbar consists of much larger grains and exhibits a rougher surface than the film grown at the low O\textsubscript{2} pressure of 5 × 10\textsuperscript{-2} mbar.

Figure(3) AFM image of the SnO\textsubscript{2}/Si thin films deposited at various oxygen pressure a) 5×10\textsuperscript{-2} mbar, b) 5×10\textsuperscript{-1} mbar and c) 10 mbar at substrate temperature 300 °C and 1.2 J/cm\textsuperscript{2} laser fluence energy
The mechanism for the grain formation is described as follow. After initial free expansion from the target surface, the mean free path of the ablated particles is reduced in the presence of gas. More specifically, at higher ambient pressure, the more collisions and scatterings occur. Then the particles lose energy to the level adequate for forming ionic complexes or molecules. If these clusters reach the substrate surface, small grains, start to grow as they become the nucleus. On the other hand, most of the ablated particles can reach the substrate in the state near the single atoms if the ambient pressure is extremely low [9].

The SEM image shows a smooth, featureless surface in agreement with the amorphous structure observed by XRD [10] in Table (1).

Table (1). morphological characteristics of the SnO$_2$ Pure films deposited at different Oxygen pressure with 300 °C substrate temperature and 1.2 J/cm$^2$ laser fluence

<table>
<thead>
<tr>
<th>sample</th>
<th>(O$_2$) Pressure mbar</th>
<th>SEM of plane grain size (nm)</th>
<th>AFM of plane grain size (nm)</th>
<th>RMS roughness</th>
</tr>
</thead>
<tbody>
<tr>
<td>SnO$_2$/Si</td>
<td>5×10$^{-2}$</td>
<td>35</td>
<td>41.6</td>
<td>4.5 nm</td>
</tr>
<tr>
<td>SnO$_2$/Si</td>
<td>5×10$^{-1}$</td>
<td>36</td>
<td>45.41</td>
<td>11.3 nm</td>
</tr>
<tr>
<td>SnO$_2$/Si</td>
<td>10</td>
<td>50</td>
<td>53.27</td>
<td>7.3 nm</td>
</tr>
</tbody>
</table>

CONCLUSIONS

at the pressure 5×10$^{-1}$ mbar The films exhibit a dominant peak on 2θ =27°, 20=34°, 20 =52° corresponding to the (110) ,(101),(211) peaks respectively with high intensity and a appearances of peak on 2θ =38°, 20=54.3° corresponding to the (200),(220) peaks respectively The increase in peak intensity indicates an
improvement in the crystallinity of the films. This leads to decrease in Full Width at Half Maximums (FWHM) of peak and increase in grain size where as , at the pressure 10 mbar as the films became amorphous .The SEM image shows a smooth agreement with the amorphous structure observed by XRD. The AFM image shows The growth at O₂ pressure of 5×10⁻¹ mbar consists of much larger a rougher surface reach to 11.3nm than the film grown at O₂ pressure of 5 ×10⁻² and 10 mbar As the pressure of the O₂ gas increases.

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